BOURNS

Certificate for RoHS Compliant Products

Bourns, Inc. certifies, as of this date, the products listed below ("Products") are designated as conforming to the requirements of the European Union's Restrictions on use of Certain Hazardous Substances in Electrical and Electronic Equipment Directive, 2002/95/EC (commonly called "RoHS") and amendments and 2011/65/EU (commonly called "RoHS Recast" or "RoHS2").

The information presented is based on Bourns' understanding of the directives and Bourns' knowledge of the materials that are used in the Products as of the date of disclosure, which, in some cases, is based on information provided by third parties.

CD1408 series	CD2320 series	CDKBP series	CDNBS04 series
CD214A-F series	CD214B-F series	CD214C-F series	
CD214A-R series	CD214B-R series	CD214C-R series	
CD214A-T series	CD214B-T series	CD214C-T series	CD214L-T
SMAJ series	SMBJ series	SMCJ series	SMLJ series
P4SMA series	P6SMA series	1.5SMC series	
		RoHS Maximum	
Restricted Substances		Concentration Value	

Restricted Substances	Concentration Value	
	(ppm)*	
Cadmium (Cd)	100	
Lead (Pb)	1,000	
Mercury (Hg)	1,000	
Hexavalent Chromium (Cr ⁺⁶)	1,000	
Polybrominated biphenyls (PBB)	1,000	
Polybrominated diphenyl ethers (PBDE)	1,000	

Maximum limit does not apply to applications covered by RoHS exemptions. Maximum Concentration Values are based on homogeneous materials as defined in the RoHS Directive.

Exemptions used (if box is checked):

- 6a. Lead as an alloying element in steel containing up to 0.35% lead by weight
- **6b.** Lead as an alloying element in aluminum containing up to 0.4% lead by weight
- 6c. Lead as an alloying element as a copper alloy containing up to 4% lead by weight.
- 7a. Lead in high melting temperature type solders (i.e., lead-based alloys containing more than 85% by weight or more lead).
- \boxtimes 7(c)-I. Electrical & electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors.
- 34. Lead in cermet-based trimmer potentiometer elements.

Signature

Date:

Ben Huang, Product Line Manager, Semiconductor Products July 13, 2015

CD3 2015

General Information: The information provided herein is to the best of Bourns, Inc. knowledge and belief. To the extent that Bourns is relying on information provided by third parties, Bourns makes no warranty as to the accuracy or completeness of such information.

Corporate Headquarters: 1200 Columbia Avenue, Riverside, CA 92507